| ASSOCIATION CONNECTING<br>ELECTRONICS INDUSTRIES<br>INDUSTRIES<br>International and P | IPC, Bannockt  | ourn, Illinois. A | Il rights reserved u ntions. | nder both     | This docum<br>level parts, t  | ent is a declarati<br>the declaration e | on of the subs | stances withi<br>11 lower leve | in the manufacture<br>el materials for wh | er listed it hich the m         | em. Note: if<br>anufacturer | the item is an as has engineering | sembly with lower responsibility. |
|---|--|-------------------|------------------------------|---------------|---|---|----------------|--------------------------------|---|---------------------------------|-----------------------------|-----------------------------------|-----------------------------------|
|   |  |                   |                              |               | Type * Declaration Class *<br>oute Class 6 - RoHS Yes/No, Homogeneous Mater |   |                |                                | als and Mfg Information                   |                                 |                             |                                   |                                   |
| Supplier Information  |  |                   |                              |               |   |   |                |                                |   |                                 |                             |                                   |                                   |
| Company name*   |  | Company unique ID |                              |               |   | Unique ID Authority                     |                |                                |   | Response Date*                  |                             |                                   |                                   |
| onsemi  |  |                   |                              |               |   |   |                |                                |   | 2024-05-17                      |                             |                                   |                                   |
| Contact Name Title - C  |  |                   | itle - Contact               |               |   | Phone - Contact*                        |                |                                |   | Email - Contact*                |                             |                                   |                                   |
| Product-Env-Stewards Prod   |  |                   | Product Enviro Compliance    |               |   | NA                                      |                |                                |   | Product-Env-Stewards@onsemi.com |                             |                                   |                                   |
| Authorized Representative* Title -  |  |                   | itle - Representative        |               |   | Phone - Representative*                 |                |                                |   | Email - Representative*         |                             |                                   |                                   |
| Product-Env-Stewards Prod   |  |                   | Product Enviro Compliance    |               |   | NA                                      |                |                                |   | Product-Env-Stewards@onsemi.com |                             |                                   |                                   |
| Requester Item Number   | er Mfr Item Nun                                      |                   | Number Mfr Item Name         |               |   | Effective Date                          | Version        | Manu                           | Manufacturing Site                        |                                 | Veight*                     | UOM                               | Unit Type                         |
|   | FODM3  | 083R2             | 4SO RP TRIAC T&R             |               |   | 2024-05-17                              |                | CP7                            | CP7                                       |                                 | 6.8354                      | mg                                | Each                              |
| Manufacturing Proccess Inform   | ation  |                   |                              |               |   |   |                | ·                              |   |                                 |                             |                                   |                                   |
| Terminal Plating / Grid Array M   | Terminal Plating / Grid Array Material Terminal Base |                   | Alloy J                      | J-STD-020 MSL | Rating  | Peak Proc                               | ess Body Tem   | perature M                     | fax Time at Peak                          | Temperatu                       | ire Numb                    | er of Reflow Cyc                  | les                               |
| Matte Tin (Sn) - annealed CU Alloy  |  | CU Alloy          | 1                            | 1             |   | 260                                     | С              | 2 30                           | 0   | second                          | ls 3                        |                                   |                                   |
| Comments  |  |                   |                              |               |   |   |                |                                |   |                                 |                             |                                   |                                   |
| level 1 - maximum time at peak tempera  | ture during so                                       | ldering is 10-3   | 0 seconds                    |               |   |   |                |                                |   |                                 |                             |                                   |                                   |
| For more information regarding materia  | l composition  | please refer to   | o page 3                     |               |   |   |                |                                |   |                                 |                             |                                   |                                   |

| RoHS Material Composition Declaration  |   |  |   | Declaration Type *                              | Detailed  |  |  |  |  |  |
|--|---|--|---|---|---|--|--|--|--|--|
| Directive 2015/863/EU amending RoHS<br>Directive 2011/65/EU  | RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP). |  |   |   |   |  |  |  |  |  |
| cadmium, hexavalentchromium, polybrominate<br>contains a RoHS restricted substance inexcess<br>encompass all such components. Supplier certif<br>as of the date that Supplier completes this form<br>Company acknowledges that Supplier may hav<br>independently verified information provided by<br>certification in this paragraph. If the Company a | ed biphenyls and/or polybrominated dip<br>of an applicable quantity limit, please ir<br>ies that it gathered the information it pro-<br>.Supplier acknowledges that Company<br>e relied on informationprovided by othe<br>v others, Supplier agrees that, at a minin<br>and the Supplier enter into a written agre<br>pource of the Supplier's liability and the  | henyl ethers (each a "<br>ndicate below which, i<br>ovides in this form us<br>will rely on this certifiers<br>in completing this<br>num, itssuppliers have<br>eement with respect to<br>Company's remedies | RoHS restricted substance") in exce<br>if any, RoHS exemption you believe<br>ing appropriate methods to ensure if<br>ication in determining the complian<br>form, and that Supplier may not have<br>e provided certifications regarding the<br>to the identified part, the terms and cc<br>for issues that arise regarding inform | ce of its products with European Union membe    | ove. If a homogeneous material within the part<br>er level components, the declaration shall<br>l correct to the best of its knowledge and belief,<br>r state laws that implement the RoHS Directive.<br>wever, in situations where Supplier has not<br>tions are at least as comprehensive as the<br>anty rights and/or remedies provided as part of |  |  |  |  |  |
| RoHS Declaration * 1 - Item(s)   | does not contain RoHS restricted substa   | ances per the definitio  | on above  | Supplier Acceptance                             | * Accepted  |  |  |  |  |  |
| Exemption: If the declared item does not con applicable exemptions.  | ntain RoHS restricted substances per  | the definition above   | except for defined RoHS exempti   | ons, then select the corresponding response i   | n the RoHS Declaration above and choose all   |  |  |  |  |  |
| Exemption List Version   | EL-2011/534/EU  |  |   |   |   |  |  |  |  |  |
| Declaration Signature  |   |  |   |   |   |  |  |  |  |  |
| Instructions: Complete all of the required fin<br>Requester) and click on Submit Form to have  | elds on all pages of this form. Select the form returned to the Requester   | he "Accepted" on th  | e Supplier Acceptance drop-down   | . This will display the signature area. Digital | lly sign the declaration (if required by the  |  |  |  |  |  |
| Supplier Digital Signature Ra  | stislav Drska   | Le   |   |   |   |  |  |  |  |  |

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

| Homogeneous Material | Weight | Unit of Measure | Level    | Substance                            | CAS        | Exempt | Weight  | Unit of Measure |
|----------------------|--------|-----------------|----------|--------------------------------------|------------|--------|---------|-----------------|
| Coupling Gel         | 4.9    | mg              | Supplier | Titanium Dioxide (TiO2)              | 13463-67-7 |        | 2.205   | mg              |
|                      |        |                 | Supplier | Dimethyl Cyclosiloxanes              | 69430-24-6 |        | 0.49    | mg              |
|                      |        |                 | Supplier | Trimethoxy(methyl)silane (C4H12O3Si) | 1185-55-3  |        | 2.205   | mg              |
| Die                  | 2.0124 | mg              | В        | Gallium Arsenide (AsGa)              | 1303-00-0  |        | 0.6538  | mg              |
|                      |        |                 | Supplier | Silicon (Si)                         | 7440-21-3  |        | 1.3586  | mg              |
| Die Attach           | 0.17   | mg              | Supplier | Silver (Ag)                          | 7440-22-4  |        | 0.1326  | mg              |
|                      |        |                 | Supplier | Phenolic Resin-2                     | 54208-63-8 |        | 0.0374  | mg              |
| Lead Frame           | 20.6   | mg              | Supplier | Silver (Ag)                          | 7440-22-4  |        | 0.0021  | mg              |
|                      |        |                 | Supplier | Zinc (Zn)                            | 7440-66-6  |        | 0.0247  | mg              |
|                      |        |                 | Supplier | Iron (Fe)                            | 7439-89-6  |        | 0.4738  | mg              |
|                      |        |                 | Supplier | Copper (Cu)                          | 7440-50-8  |        | 20.0932 | mg              |
|                      |        |                 | Supplier | Phosphorus (P)                       | 7723-14-0  |        | 0.0062  | mg              |
| Mold Compound-Black  | 27.9   | mg              | Supplier | Ortho Cresol Novolac Resin           | 29690-82-2 |        | 3.627   | mg              |
|                      |        |                 | Supplier | Carbon Black (C)                     | 1333-86-4  |        | 0.279   | mg              |
|                      |        |                 | Supplier | Aluminum Hydroxide (Al(OH)3)         | 21645-51-2 |        | 2.511   | mg              |
|                      |        |                 | Supplier | Fused Silica (SiO2)                  | 60676-86-0 |        | 19.53   | mg              |
|                      |        |                 | Supplier | Phenolic Resin (Novolac)             | 9003-35-4  |        | 1.953   | mg              |
| Mold Compound-White  | 21.1   | mg              | Supplier | Ortho Cresol Novolac Resin           | 29690-82-2 |        | 4.22    | mg              |
|                      |        |                 | Supplier | Fused Silica (SiO2)                  | 60676-86-0 |        | 14.77   | mg              |
|                      |        |                 | Supplier | Phenolic Resin (Novolac)             | 9003-35-4  |        | 2.11    | mg              |
| Plating              | 0.1    | mg              | Supplier | Tin (Sn)                             | 7440-31-5  |        | 0.1     | mg              |
| Wire Bond - Au       | 0.053  | mg              | Supplier | Gold (Au)                            | 7440-57-5  |        | 0.053   | mg              |